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# PIC16(L)F18455/56

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## 28-Pin Full-Featured, Low Pin Count Microcontrollers with XLP

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### Description

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PIC16(L)F184XX microcontrollers feature Intelligent Analog, Core Independent Peripherals (CIPs) and communication peripherals combined with eXtreme Low-Power (XLP) for a wide range of general purpose and low-power applications. Features such as a 12-bit Analog-to-Digital Converter with Computation (ADC<sup>2</sup>), Memory Access Partitioning (MAP), the Device Information Area (DIA), Power-saving operating modes, and Peripheral Pin Select (PPS), offer flexible solutions for a wide variety of custom applications.

### Core Features

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- C Compiler Optimized RISC Architecture
- Only 50 Instructions
- Operating Speed:
  - DC – 32 MHz clock input
  - 125 ns minimum instruction cycle
- Interrupt Capability
- 16-Level Deep Hardware Stack
- Timers:
  - Up to two 24-bit timers
  - Up to four 8-bit timers
  - Up to four 16-bit timers
- Low-Current Power-on Reset (POR)
- Configurable Power-up Timer (PWRT)
- Brown-out Reset (BOR)
- Low-Power BOR (LPBOR) Option
- Windowed Watchdog Timer (WWDT):
  - Variable prescaler selection
  - Variable window size selection
  - Configurable in hardware (Configuration Words) and/or software
- Programmable Code Protection

### Memory

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- Up to 28 KB Program Flash Memory
- Up to 2 KB Data SRAM Memory

- 256B Data EEPROM
- Direct, Indirect and Relative Addressing modes
- Memory Access Partition (MAP):
  - Write-protect
  - Customizable partition
- Device Information Area (DIA)
- Device Configuration Information (DCI)

## Operating Characteristics

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- Operating Voltage Range:
  - 1.8V to 3.6V (PIC16LF184XX)
  - 2.3V to 5.5V (PIC16F184XX)
- Temperature Range:
  - Industrial: -40°C to 85°C
  - Extended: -40°C to 125°C

## Power-Saving Operation Modes

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- Doze: CPU and Peripherals Running at Different Cycle Rates (typically CPU is lower)
- Idle: CPU Halted While Peripherals Operate
- Sleep: Lowest Power Consumption
- Peripheral Module Disable (PMD):
  - Ability to selectively disable hardware module to minimize active power consumption of unused peripherals
- Extreme Low-Power mode (XLP)
  - Sleep: 500 nA typical @ 1.8V
  - Sleep and Watchdog Timer: 900 nA typical @ 1.8V

## eXtreme Low-Power (XLP) Features

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- Sleep mode: 50 nA @ 1.8, typical
- Watchdog Timer: 500 nA @ 1.8V, typical
- Secondary Oscillator: 500 nA @ 32 kHz
- Operating Current:
  - 8 uA @ 32 kHz, 1.8V, typical
  - 32 uA/MHz @ 1.8V, typical

## Digital Peripherals

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- Configurable Logic Cell (CLC):
  - 4 CLCs
  - Integrated combinational and sequential logic
- Complementary Waveform Generator (CWG):
  - 3 CWGs

- Rising and falling edge dead-band control
- Full-bridge, half-bridge, 1-channel drive
- Multiple signal sources
- Capture/Compare/PWM (CCP) modules:
  - 5 CCPs
  - 16-bit resolution for Capture/Compare modes
  - 10-bit resolution for PWM mode
- Pulse-Width Modulators (PWM):
  - 2 10-bit PWMs
- Numerically Controlled Oscillator (NCO):
  - Precision linear frequency generator (@50% duty cycle) with 0.0001% step size of source input clock
  - Input Clock:  $0 \text{ Hz} < f_{\text{NCO}} < 32 \text{ MHz}$
  - Resolution:  $f_{\text{NCO}}/2^{20}$
- Peripheral Pin Select (PPS):
  - I/O pin remapping of digital peripherals
- Serial Communications:
  - EUSART
    - 2 EUSART(s)
    - RS-232, RS-485, LIN compatible
    - Auto-Baud Detect, Auto-wake-up on Start.
  - Master Synchronous Serial Port (MSSP)
    - 2 MSSP(s)
    - SPI
    - I<sup>2</sup>C, SMBus and PMBus™ compatible
- Data Signal Modulator (DSM):
  - Modulates a carrier signal with digital data to create custom carrier synchronized output waveforms
- Up to 26 I/O Pins:
  - Individually programmable pull-ups
  - Slew rate control
  - Interrupt-on-change with edge-select
  - Input level selection control (ST or TTL)
  - Digital open-drain enable
- Timer modules:
  - Timer0:
    - 8/16-bit timer/counter
    - Synchronous or asynchronous operation
    - Programmable prescaler/postscaler
    - Time base for capture/compare function
  - Timer1/3/5 with gate control:
    - 16-bit timer/counter
    - Programmable internal or external clock sources
    - Multiple gate sources

- Multiple gate modes
- Time base for capture/compare function
- Timer2/4/6 with Hardware Limit Timer:
  - 8-bit timers
  - Programmable prescaler/postscaler
  - Time base for PWM function
  - Hardware Limit (HLT) and one-shot extensions
  - Selectable clock sources
- Signal Measurement Timer (SMT)
  - 2 SMT(s)
  - 24-bit timer/counter with programmable prescaler

## Analog Peripherals

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- Analog-to-Digital Converter with Computation (ADC<sup>2</sup>):
  - 12-bit with up to 24 external channels
  - Conversion available during Sleep
  - Automated post-processing
  - Automated math functions on input signals:
    - Averaging, filter calculations, oversampling and threshold comparison
  - Integrated charge pump for low-voltage operation
  - CVD support
- Zero-Cross Detect (ZCD):
  - AC high voltage zero-crossing detection for simplifying TRIAC control
  - Synchronized switching control and timing
- Temperature Sensor Circuit
- Comparator:
  - 2 Comparators
  - Fixed Voltage Reference at (non)inverting input(s)
  - Comparator outputs externally accessible
- Digital-to-Analog Converter (DAC):
  - 5-bit resolution, rail-to-rail
  - Positive Reference Selection
  - Unbuffered I/O pin output
  - Internal connections to ADCs and comparators
- Fixed Voltage Reference (FVR) module:
  - 1.024V, 2.048V and 4.096V output levels

## Flexible Oscillator Structure

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- High-Precision Internal Oscillator:
  - Software-selectable frequency range up to 32 MHz
  - $\pm 2\%$  at calibration (nominal)
- 4x PLL for use with External Sources:
  - up to 32 MHz (4-8 MHz input)

- 2x PLL for use with the HFINTOSC:
  - up to 32 MHz
- Low-Power Internal 31 kHz Oscillator (LFINTOSC)
- External 32.768 kHz Crystal Oscillator (SOCS)
- External Oscillator Block with:
  - Three crystal/resonator modes up to 20 MHz
  - Three external clock modes up to 32 MHz
  - Fail-Safe Clock Monitor
    - Detects clock source failure
  - Oscillator Start-up Timer (OST)
    - Ensures stability of crystal oscillator sources

## PIC16(L)F184XX Family Types

**Table 1. Devices Included In This Data Sheet**

Device	Program Flash Memory (Words)	Program Flash Memory (Kbytes)	Data Memory (EEPROM) (bytes)	Data SRAM (bytes)	I/O's <sup>(2)</sup>	12-bit ADC <sup>2</sup> (ch)	5-bit DAC	Comparators	CWG	Clock Ref	Timers (8/16-bit)	CCP	PWM	NCO	EUSART	MSSP (I <sup>2</sup> C/SPI)	CLC	DSM	PPS	XLP	PMD	Windowed Watchdog Timer	Memory Access Partition	Device Information Area	Debug <sup>(1)</sup>
PIC16(L)F18455	8192	14	256	1024	26	24	1	2	3	1	4/4	5	2	1	2	2	4	1	Y	Y	Y	Y	Y	Y	I
PIC16(L)F18456	16384	28	256	2048	26	24	1	2	3	1	4/4	5	2	1	2	2	4	1	Y	Y	Y	Y	Y	Y	I

**Note:**

1. I - Debugging integrated on-chip.
2. One pin is input-only.

**Table 2. Devices Not Included In This Data Sheet**

Device	Program Flash Memory (Words)	Program Flash Memory (Kbytes)	Data Memory (EEPROM) (bytes)	Data SRAM (bytes)	I/O's <sup>(2)</sup>	12-bit ADC <sup>2</sup> (ch)	5-bit DAC	Comparators	CWG	Clock Ref	Timers (8/16-bit)	CCP	PWM	NCO	EUSART	MSSP (I <sup>2</sup> C/SPI)	CLC	DSM	PPS	XLP	PMD	Windowed Watchdog Timer	Memory Access Partition	Device Information Area	Debug <sup>(1)</sup>	
PIC16(L)F18424	4096	7	256	512	12	11	1	2	2	1	4/4	4	2	1	1	1	4	1	Y	Y	Y	Y	Y	Y	Y	I
PIC16(L)F18425	8192	14	256	1024	12	11	1	2	2	1	4/4	4	2	1	1	2	4	1	Y	Y	Y	Y	Y	Y	Y	I
PIC16(L)F18426	16384	28	256	2048	12	11	1	2	2	1	4/4	4	2	1	1	2	4	1	Y	Y	Y	Y	Y	Y	Y	I
PIC16(L)F18444	4096	7	256	512	18	17	1	2	2	1	4/4	4	2	1	1	1	4	1	Y	Y	Y	Y	Y	Y	Y	I
PIC16(L)F18445	8192	14	256	1024	18	17	1	2	2	1	4/4	4	2	1	1	2	4	1	Y	Y	Y	Y	Y	Y	Y	I
PIC16(L)F18446	16384	28	256	2048	18	17	1	2	2	1	4/4	4	2	1	1	2	4	1	Y	Y	Y	Y	Y	Y	Y	I

Data Sheet Index:

1. [DS40002000A, PIC16\(L\)F18424/44 Data Sheet, 14/20-Pin Full-Featured, Low Pin Count Microcontrollers with XLP](#)
2. [DS40002002A, PIC16\(L\)F18425/45 Data Sheet, 14/20-Pin Full-Featured, Low Pin Count Microcontrollers with XLP](#)
3. [DS40001985A, PIC16\(L\)F18426/46 Data Sheet, 14/20-Pin Full-Featured, Low Pin Count Microcontrollers with XLP](#)

## Packages

Packages	SPDIP	SOIC	SSOP	VQFN (4x4)
PIC16(L)F18455	•	•	•	•
PIC16(L)F18456	•	•	•	•

**Note:** Pin details are subject to change.

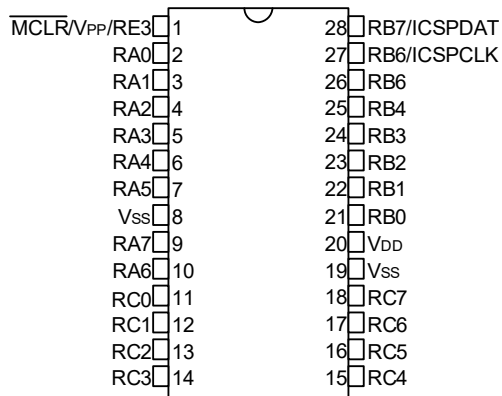


**Important:** For other small form-factor package availability and marking information, visit [www.microchip.com/packaging](http://www.microchip.com/packaging) or contact your local sales office.

Pin Diagrams

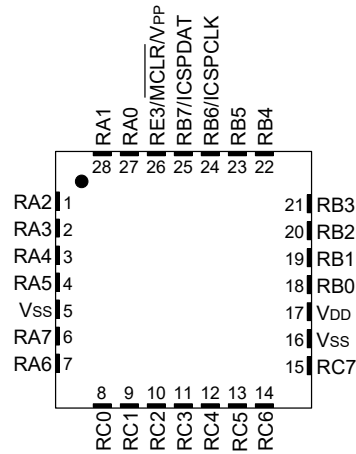
1 28-Pin Diagrams

Figure 1. 28-pin SPDIP, SSOP, SOIC



Rev. 00-00028A  
3/6/2017

Figure 2. 28-pin VQFN



Rev. 00-00028B  
6/23/2017

**Note:** It is recommended that the exposed bottom pad be connected to V<sub>SS</sub>.

Related Links

1 [28-Pin Allocation Table](#)



Pin Allocation Tables

1 28-Pin Allocation Table

I/O	28-pin SPDIF/SOIC/SSOP	28-pin VQFN	ADC	Reference	Comparator	NCO	DAC	DSM	Timers	CCP	PWM	CWG	MSSP	ZCD	EUSART	CLC	CLKR	Interrupts	Pull-Up	Basic	
RA0	2	27	ANA0	—	C1IN0- C2IN0-	—	—	—	—	—	—	—	—	—	—	CLCIN0(1)	—	IOCA0	Y	—	
RA1	3	28	ANA1	—	C1IN1- C2IN1-	—	—	—	—	—	—	—	—	—	—	CLCIN1(1)	—	IOCA1	Y	—	
RA2	4	1	ANA2	ADCVREF-	C1IN0+ C2IN0+	—	DAC1VREF- DAC1OUT1	—	—	—	—	—	—	—	—	—	—	—	IOCA2	Y	—
RA3	5	2	ANA3	ADCVREF+	C1IN1+	—	DAC1VREF+	MDCARL(1)	—	—	—	—	—	—	—	—	—	—	IOCA3	Y	—
RA4	6	3	ANA4	—	—	—	—	MDCARH(1)	T0CKI(1)	CCP5IN(1)	—	—	—	—	—	—	—	—	IOCA4	Y	—
RA5	7	4	ANA5	—	—	—	—	MDSRC(1)	—	—	—	—	SS1(1)	—	—	—	—	—	IOCA5	Y	—
RA6	10	7	ANA6	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCA6	Y	OSC2 CLKOUT
RA7	9	6	ANA7	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCA7	Y	OSC1 CLKIN
RB0	21	18	ANB0	—	C2IN1+	—	—	—	—	CCP4IN(1)	—	CWG1IN(1)	—	ZCD1	—	—	—	—	IOCB0	Y	INT(1)
RB1	22	19	ANB1	—	C1IN3- C2IN3-	—	—	—	—	—	—	CWG2IN(1)	SCK2(1) SCL2(1,3)	—	—	—	—	—	IOCB1	Y	—
RB2	23	20	ANB2	—	—	—	—	—	—	—	—	CWG3IN(1)	SDI2(1) SDA2(1,3)SS2(1)	—	—	—	—	—	IOCB2	Y	—
RB3	24	21	ANB3	—	C1IN2- C2IN2-	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCB3	Y	—
RB4	25	22	ANB4 ADACT(1)	—	—	—	—	—	T5G(1) SMT2WIN(1)	—	—	—	—	—	—	—	—	—	IOCB4	Y	—
RB5	26	23	ANB5	—	—	—	—	—	T1G(1) SMT2SIG(1)	CCP3IN(1)	—	—	—	—	—	—	—	—	IOCB5	Y	—
RB6	27	24	ANB6	—	—	—	—	—	—	—	—	—	—	—	CK2(1,3)	CLCIN2(1)	—	—	IOCB6	Y	ICSPCLK ICDCLK
RB7	28	25	ANB7	—	—	—	DAC1OUT2	—	T6IN(1)	—	—	—	—	—	RX2(1) DT2(1,3)	—	—	—	IOCB7	Y	ICSPDAT ICDDAT
RC0	11	8	ANC0	—	—	—	—	—	T1CKI(1) T3CKI(1) T3G(1)	—	—	—	—	—	—	—	—	—	IOCC0	Y	SOSCO

IO	28-pin SPDI/SOC/SSOP	28-pin VQFN	ADC	Reference	Comparator	NCO	DAC	DSM	Timers	CCP	PWM	CWG	INSSP	ZCD	EUSART	GLC	CLKR	Interrupts	Pull-up	Basic	
									SMT1WIN <sup>(1)</sup>												
RC1	12	9	ANC1	—	—	—	—	—	SMT1SIG <sup>(1)</sup>	CCP2IN <sup>(1)</sup>	—	—	—	—	—	—	—	IOCC1	Y	SOSCI	
RC2	13	10	ANC2	—	—	—	—	—	T5CKI <sup>(1)</sup>	CCP1IN <sup>(1)</sup>	—	—	—	—	—	—	—	IOCC2	Y	—	
RC3	14	11	ANC3	—	—	—	—	—	T2IN <sup>(1)</sup>	—	—	—	SCK1 <sup>(1)</sup> SCL1 <sup>(1,3)</sup>	—	—	—	—	IOCC3	Y	—	
RC4	15	12	ANC4	—	—	—	—	—	—	—	—	—	SDI1 <sup>(1)</sup> SDA1 <sup>(1,3)</sup>	—	—	—	—	IOCC4	Y	—	
RC5	16	13	ANC5	—	—	—	—	—	T4IN <sup>(1)</sup>	—	—	—	—	—	—	—	—	IOCC5	Y	—	
RC6	17	14	ANC6	—	—	—	—	—	—	—	—	—	—	—	—	CK1 <sup>(1,3)</sup>	—	IOCC6	Y	—	
RC7	18	15	ANC7	—	—	—	—	—	—	—	—	—	—	—	—	RX1 <sup>(1)</sup> DT1 <sup>(1,3)</sup>	—	IOCC7	Y	—	
RE3	1	26	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCE3	Y	MCLR VPP	
VDD	20	17	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	8	5	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS
VSS	19	16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS
OUT <sup>(2)</sup>	—	—	ADCGRDA	—	C1OUT	NCO1OUT	—	DSM1OUT	TMR0OUT	CCP1OUT	PWM6OUT	CWG1A CWG2A CWG3A	SDO1 SDO2	—	DT1 <sup>(3)</sup> DT2 <sup>(3)</sup>	CLC1OUT	CLKR	—	—	—	
	—	—	ADCGRDB	—	C2OUT	—	—	—	—	CCP2OUT	PWM7OUT	CWG1B CWG2B CWG3B	SCK1 SCK2	—	CK1 <sup>(3)</sup> CK2 <sup>(3)</sup>	CLC2OUT	—	—	—	—	
	—	—	—	—	—	—	—	—	—	CCP3OUT	—	CWG1C CWG2C CWG3C	SCL1 <sup>(3)</sup> SCL2 <sup>(3)</sup>	—	TX1 TX2	CLC3OUT	—	—	—	—	
	—	—	—	—	—	—	—	—	—	CCP4OUT	—	CWG1D CWG2D CWG3D	SDA1 <sup>(3)</sup> SDA2 <sup>(3)</sup>	—	—	CLC4OUT	—	—	—	—	
—	—	—	—	—	—	—	—	—	—	CCP5OUT	—	—	—	—	—	—	—	—	—	—	

**Note:**

1. This is a PPS re-mappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.
2. All digital output signals shown in these rows are PPS re-mappable. These signals may be mapped to output onto one of several PORTx pin options.
3. This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

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## 1. Device Overview

This document contains device-specific information for the following devices:

• PIC16F18455	• PIC16LF18455
• PIC16F18456	• PIC16LF18456

### 1.1 New Core Features

#### 1.1.1 XLP Technology

All of the devices in the PIC16(L)F184XX family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- **Alternate Run Modes:** By clocking the controller from the secondary oscillator or the internal oscillator block, power consumption during code execution can be reduced by as much as 90%.
- **Multiple Idle Modes:** The controller can also run with its CPU core disabled but the peripherals still active. In these states, power consumption can be reduced even further, to as little as 4% of normal operation requirements.
- **On-the-Fly Mode Switching:** The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- **Peripheral Module Disable:** Modules that are not being used in the code can be selectively disabled using the PMD module. This further reduces the power consumption.

#### 1.1.2 Multiple Oscillator Options and Features

All of the devices in the PIC16(L)F184XX family offer several different oscillator options. The PIC16(L)F184XX family can be clocked from several different sources:

- HFINTOSC
  - 1-32 MHz precision digitally controlled internal oscillator
- LFINTOSC
  - 31 kHz internal oscillator
- EXTOSC
  - External clock (EC)
  - Low-power oscillator (LP)
  - Medium-power oscillator (XT)
  - High-power oscillator (HS)
- SOSC
  - Secondary oscillator circuit optimized for 32 kHz clock crystals
- A Phase Lock Loop (PLL) frequency multiplier (2x/4x) is available to the External Oscillator modes enabling clock speeds of up to 32 MHz
- Fail-Safe Clock Monitor: This option constantly monitors the main clock source against a reference signal provided by the LFINTOSC. If a clock failure occurs, the controller is switched to the internal oscillator block, allowing for continued operation or a safe application shutdown.

## 1.2 Other Special Features

- **12-bit A/D Converter with Computation:** This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reduce code overhead. It has a new module called ADC<sup>2</sup> with computation features, which provides a digital filter and threshold interrupt functions.
- **Memory Endurance:** The Flash cells for both program memory and data EEPROM are rated to last for many thousands of erase/write cycles – up to 10K for program memory and 100K for EEPROM. Data retention without refresh is conservatively estimated to be greater than 40 years.
- **Self-programmability:** These devices can write to their own program memory spaces under internal software control. By using a boot loader routine located in the protected Boot Block at the top of program memory, it becomes possible to create an application that can update itself in the field.
- **Enhanced Peripheral Pin Select:** The Peripheral Pin Select (PPS) module connects peripheral inputs and outputs to the device I/O pins. Only digital signals are included in the selections. All analog inputs and outputs remain fixed to their assigned pins.
- **Windowed Watchdog Timer (WWDT):**
  - Timer monitoring of overflow and underflow events
  - Variable prescaler selection
  - Variable window size selection
  - All sources configurable in hardware or software

## 1.3 Details on Individual Family Members

The devices of the PIC16(L)F184XX family described in the current datasheet are available in 28-pin packages. The block diagram for this device is shown in [Figure 1-1](#).

The devices have the following differences:

1. Program Flash Memory
2. Data Memory SRAM
3. Data Memory EEPROM
4. A/D channels
5. I/O ports
6. Enhanced USART
7. Input Voltage Range/Power Consumption

All other features for devices in this family are identical. These are summarized in the following Device Features table.

The pinouts for all devices are listed in the pin summary tables.

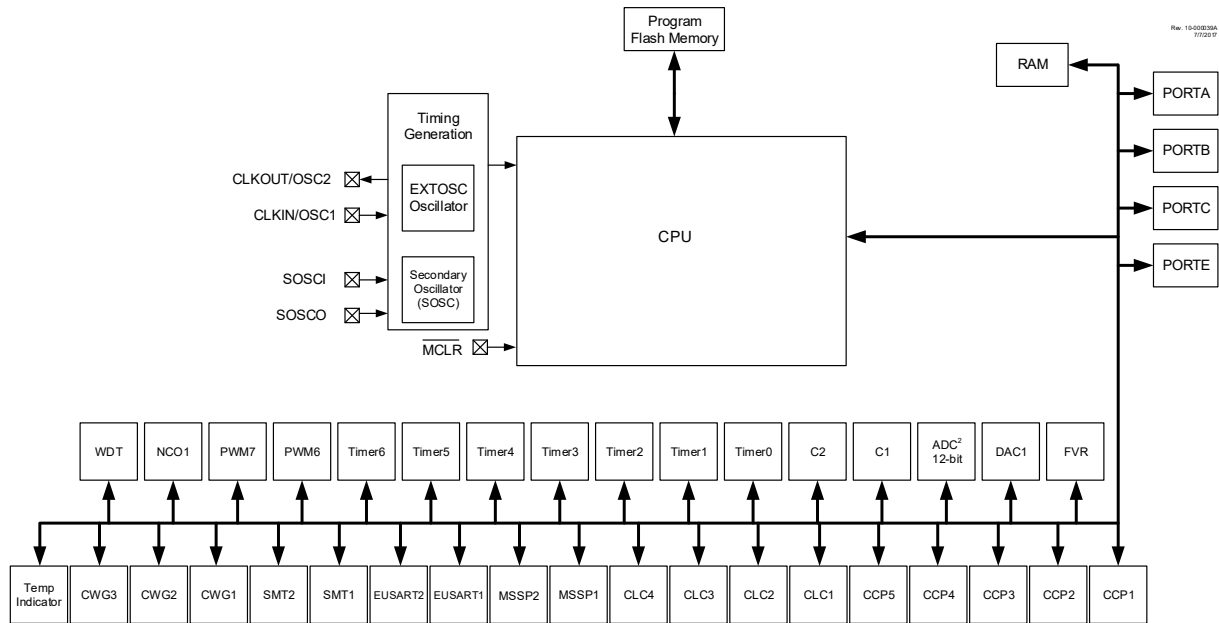
**Table 1-1. Device Features**

Features	PIC16(L)F18455	PIC16(L)F18456
Program Memory (KBytes)	14	28
Program Memory (Instructions)	8192	16384
Data Memory (Bytes)	1024	2048
Data EEPROM Memory (Bytes)	256	256

Features	PIC16(L)F18455	PIC16(L)F18456
Packages	28 - SPDIP 28 - SSOP 28 - SOIC (7.5 mm) 28 - vQFN (4x4)	28 - SPDIP 28 - SSOP 28 - SOIC (7.5 mm) 28 - vQFN (4x4)
I/O Ports	A, B, C	A, B, C
Capture/Compare/PWM Modules (CCP)	5	5
Configurable Logic Cell (CLC)	4	4
10-Bit Pulse-Width Modulator (PWM)	2	2
12-Bit Analog-to-Digital Module (ADC <sup>2</sup> ) with Computation Accelerator	24 channels	24 channels
5-Bit Digital-to-Analog Module (DAC)	1	1
Comparators	2	2
Numerical Controlled Oscillator (NCO)	1	1
Interrupt Sources	47	47
Timers (16-/8-bit)	4	4
Serial Communications	2 MSSP 2 EUSART	2 MSSP 2 EUSART
Complementary Waveform Generator (CWG)	3	3
Zero-Cross Detect (ZCD)	1	1
Data Signal Modulator (DSM)	1	1
Reference Clock Output Module	1	1
Peripheral Pin Select (PPS)	YES	YES
Peripheral Module Disable (PMD)	YES	YES
Programmable Brown-out Reset (BOR)	YES	YES
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Overflow, Stack Underflow (PWRT, OST), MCLR, WDT	POR, BOR, RESET Instruction, Stack Overflow, Stack Underflow (PWRT, OST), MCLR, WDT
Instruction Set	50 instructions	50 instructions

Features	PIC16(L)F18455	PIC16(L)F18456
	16-levels hardware stack	16-levels hardware stack
Operating Frequency	DC – 32 MHz	DC – 32 MHz

**Figure 1-1. PIC16(L)F18455/56 Device Block Diagram**



**Note:**

1. See applicable chapters for more information on peripherals.

## 1.4 Register and Bit Naming Conventions

### 1.4.1 Register Names

When there are multiple instances of the same peripheral in a device, the Peripheral Control registers will be depicted as the concatenation of a peripheral identifier, peripheral instance, and control identifier. The control registers section will show just one instance of all the register names with an 'x' in the place of the peripheral instance number. This naming convention may also be applied to peripherals when there is only one instance of that peripheral in the device to maintain compatibility with other devices in the family that contain more than one.

### 1.4.2 Bit Names

There are two variants for bit names:

- Short name: Bit function abbreviation
- Long name: Peripheral abbreviation and short name

#### 1.4.2.1 Short Bit Names

Short bit names are an abbreviation for the bit function. For example, some peripherals are enabled with the EN bit. The bit names shown in the registers are the short name variant.



Short bit names are useful when accessing bits in C programs. The general format for accessing bits by the short name is `RegisterNamebits.ShortName`. For example, the enable bit, EN, in the `CM1CON0` register can be set in C programs with the instruction `CM1CON0bits.EN = 1`.

Short names are generally not useful in assembly programs because the same name may be used by different peripherals in different bit positions. When this occurs, during the include file generation, all instances of that short bit name are appended with an underscore plus the name of the register in which the bit resides to avoid naming contentions.

### 1.4.2.2 Long Bit Names

Long bit names are constructed by adding a peripheral abbreviation prefix to the short name. The prefix is unique to the peripheral, thereby making every long bit name unique. The long bit name for the COG1 enable bit is the COG1 prefix, G1, appended with the enable bit short name, EN, resulting in the unique bit name G1EN.

Long bit names are useful in both C and assembly programs. For example, in C the `COG1CON0` enable bit can be set with the `G1EN = 1` instruction. In assembly, this bit can be set with the `BSF COG1CON0, G1EN` instruction.

### 1.4.2.3 Bit Fields

Bit fields are two or more adjacent bits in the same register. Bit fields adhere only to the short bit naming convention. For example, the three Least Significant bits of the `COG1CON0` register contain the mode control bits. The short name for this field is MD. There is no long bit name variant. Bit field access is only possible in C programs. The following example demonstrates a C program instruction for setting the COG1 to the Push-Pull mode:

```
COG1CON0bits.MD = 0x5;
```

Individual bits in a bit field can also be accessed with long and short bit names. Each bit is the field name appended with the number of the bit position within the field. For example, the Most Significant mode bit has the short bit name MD2 and the long bit name is G1MD2. The following two examples demonstrate assembly program sequences for setting the COG1 to Push-Pull mode:

Example 1:

```
MOVLW  ~ (1<<G1MD1)
ANDWF  COG1CON0, F
MOVLW  1<<G1MD2 | 1<<G1MD0
IORWF  COG1CON0, F
```

Example 2:

```
BSF    COG1CON0, G1MD2
BCF    COG1CON0, G1MD1
BSF    COG1CON0, G1MD0
```

## 1.4.3 Register and Bit Naming Exceptions

### 1.4.3.1 Status, Interrupt, and Mirror Bits

Status, interrupt enables, interrupt flags, and mirror bits are contained in registers that span more than one peripheral. In these cases, the bit name shown is unique so there is no prefix or short name variant.

### 1.4.3.2 Legacy Peripherals

There are some peripherals that do not strictly adhere to these naming conventions. Peripherals that have existed for many years and are present in almost every device are the exceptions. These exceptions were necessary to limit the adverse impact of the new conventions on legacy code.

Peripherals that do adhere to the new convention will include a table in the registers section indicating the long name prefix for each peripheral instance. Peripherals that fall into the exception category will not have this table. These peripherals include, but are not limited to the following:

- EUSART
- MSSP

#### 1.4.4 Register Legend

The table below describes the conventions for bit types and bit Reset values used in the current data sheet.

**Table 1-2. Register Legend**

Value	Description
RO	Read-only bit
W	Writable bit
U	Unimplemented bit, read as '0'
P	Programmable bit
'1'	Bit is set
'0'	Bit is cleared
x	Bit is unknown
u	Bit is unchanged
-n/n	Value at POR and BOR/Value at all other Resets
q	Reset Value is determined by hardware
f	Reset Value is determined by fuse setting
g	Reset Value at POR for PPS re-mappable signals